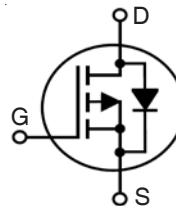


PolarP™
Power MOSFET

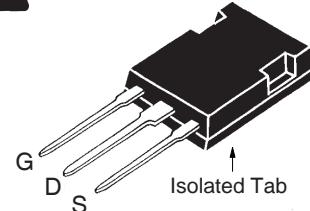
IXTR48P20P

P-Channel Enhancement Mode
Avalanche Rated



V_{DSS} = - 200V
I_{D25} = - 30A
R_{DS(on)} ≤ 93mΩ

ISOPLUS247
 E153432



G = Gate D = Drain
S = Source

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	T _J = 25°C to 150°C	- 200	V	
V_{DGR}	T _J = 25°C to 150°C, R _{GS} = 1MΩ	- 200	V	
V_{GSS}	Continuous	±20	V	
V_{GSM}	Transient	±30	V	
I_{D25}	T _C = 25°C	- 30	A	
I_{DM}	T _C = 25°C, Pulse Width Limited by T _{JM}	-144	A	
I_A	T _C = 25°C	- 48	A	
E_{AS}	T _C = 25°C	2.5	J	
dv/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C	10	V/ns	
P_D	T _C = 25°C	190	W	
T_J		-55 ... +150	°C	
T_{JM}		150	°C	
T_{stg}		-55 ... +150	°C	
T_L	1.6mm (0.062 in.) from Case for 10s	300	°C	
T_{SOLD}	Plastic Body for 10s	260	°C	
V_{ISOL}	50/60 Hz, 1 Minute	2500	V	
F_c	Mounting Force	20..120/4.5..27	N/lb.	
Weight		5	g	

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	V _{GS} = 0V, I _D = - 250μA	- 200		V
V_{GS(th)}	V _{DS} = V _{GS} , I _D = - 250μA	- 2.0		- 4.0 V
I_{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100 nA
I_{DSS}	V _{DS} = V _{DSS} , V _{GS} = 0V T _J = 125°C			- 25 μA - 200 μA
R_{DS(on)}	V _{GS} = -10V, I _D = - 24A, Note 1			93 mΩ

Features

- Silicon Chip on Direct-Copper Bond (DCB) Substrate
 - UL Recognized Package
 - Isolated Mounting Surface
 - 2500V~ Electrical Isolation
- Avalanche Rated
- The Rugged PolarP™ Process
- Low Q_G
- Fast Intrinsic Diode
- Low Drain-to-Tab Capacitance
- Low Package Inductance

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

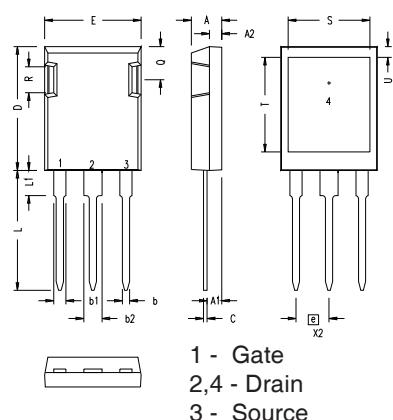
- High-Side Switches
- Push-Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Load-Switch Applications
- Fuel Injection Systems

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g _{fs}	V _{DS} = -10V, I _D = -24A, Note 1	19	32	S
C _{iss}		5400		pF
C _{oss}		1040		pF
C _{rss}		170		pF
t _{d(on)}		30		ns
t _r		46		ns
t _{d(off)}		67		ns
t _f		27		ns
Q _{g(on)}		103		nC
Q _{gs}		23		nC
Q _{gd}		40		nC
R _{thJC}			0.66	°C/W
R _{thCS}		0.15		°C/W

Source-Drain Diode

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I _s	V _{GS} = 0V			- 48 A
I _{SM}	Repetitive, Pulse Width Limited by T _{JM}			-192 A
V _{SD}	I _F = -24A, V _{GS} = 0V, Note 1			- 3.3 V
t _{rr}		260		ns
Q _{RM}		4.2		μC
I _{RM}		- 32.2		A

Note 1: Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

ISOPLUS247 (IXTR) Outline

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b1	.075	.084	1.91	2.13
b2	.115	.123	2.92	3.12
C	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
E	.620	.635	15.75	16.13
e	.215 BSC		5.45 BSC	
L	.780	.800	19.81	20.32
L1	.150	.170	3.81	4.32
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.520	.540	13.21	13.72
T	.620	.640	15.75	16.26
U	.065	.080	1.65	2.03

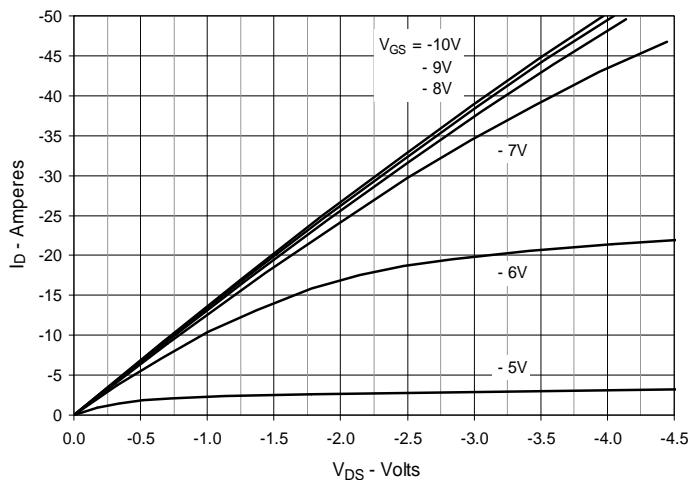
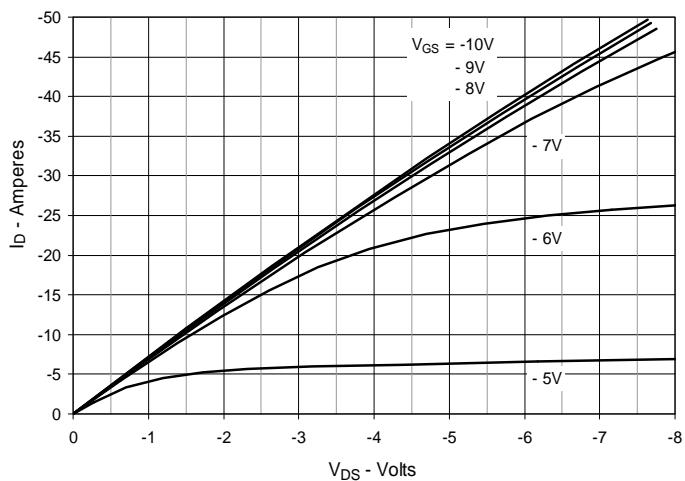
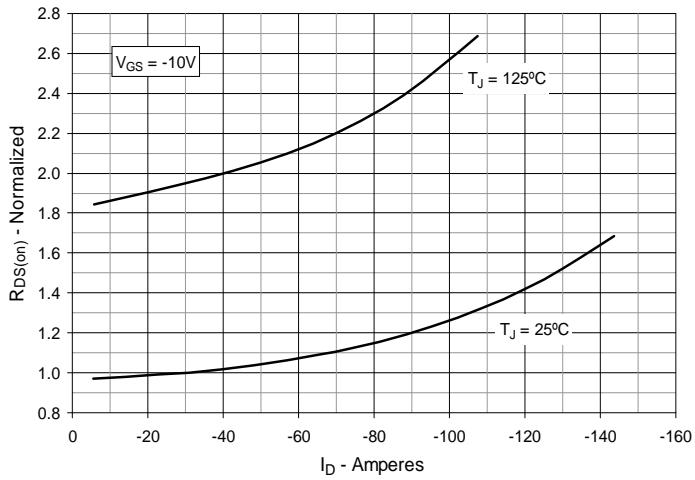
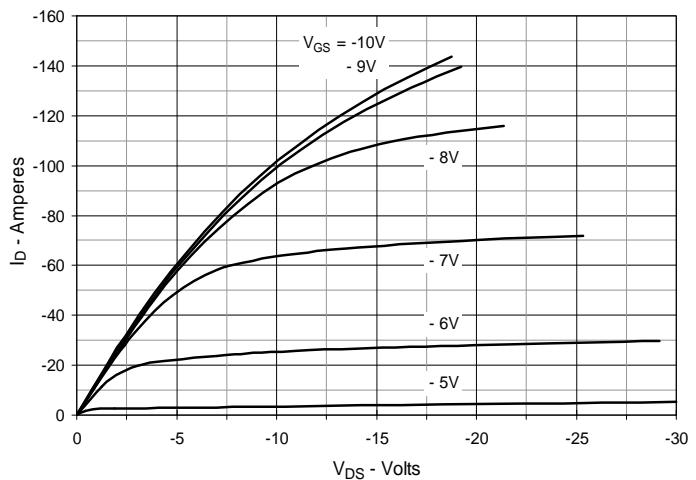
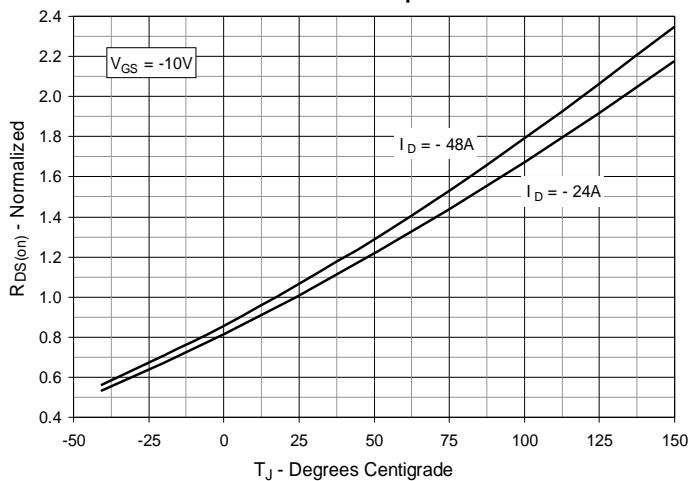
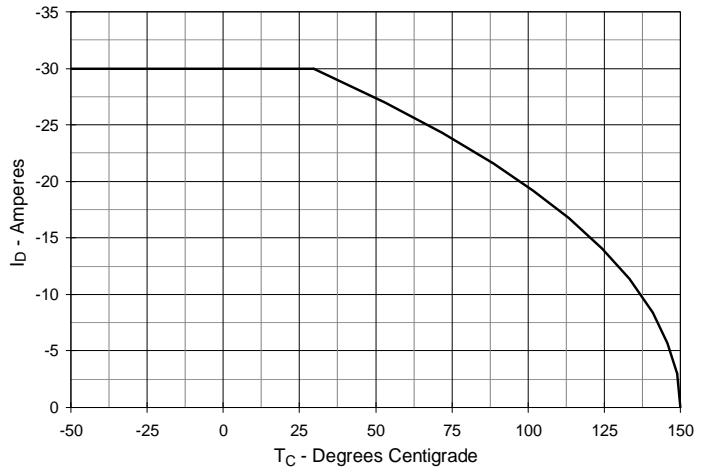
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$ **Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$** **Fig. 5. $R_{DS(on)}$ Normalized to $I_D = -24\text{A}$ Value vs. Drain Current****Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$** **Fig. 4. $R_{DS(on)}$ Normalized to $I_D = -24\text{A}$ Value vs. Junction Temperature****Fig. 6. Maximum Drain Current vs. Case Temperature**

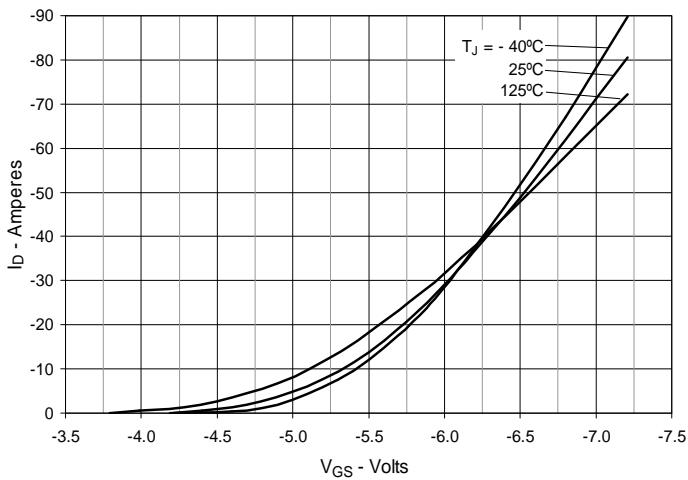
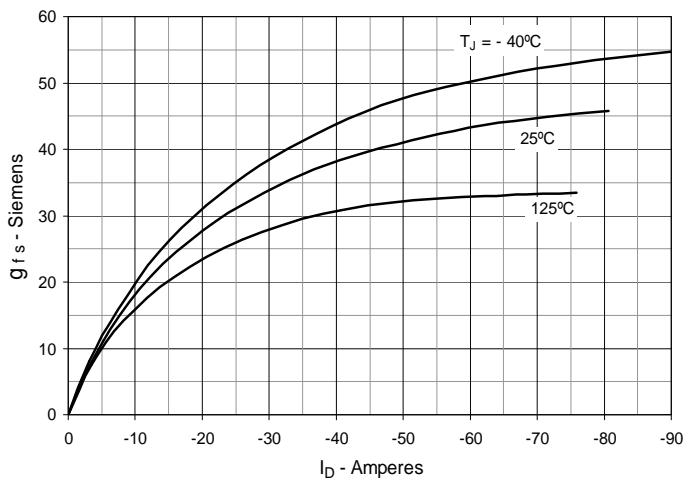
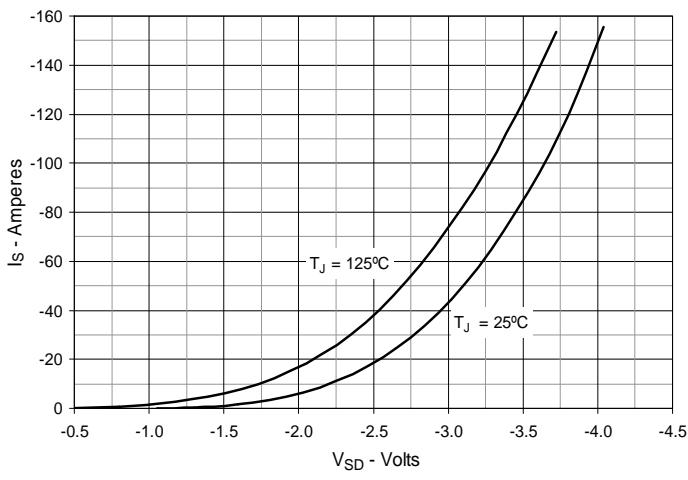
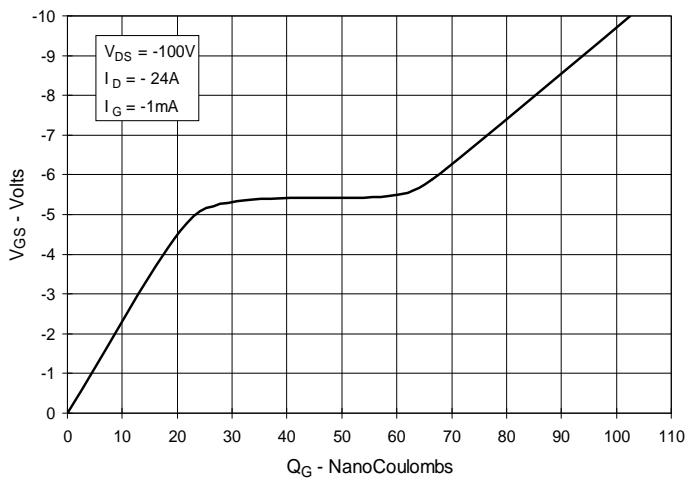
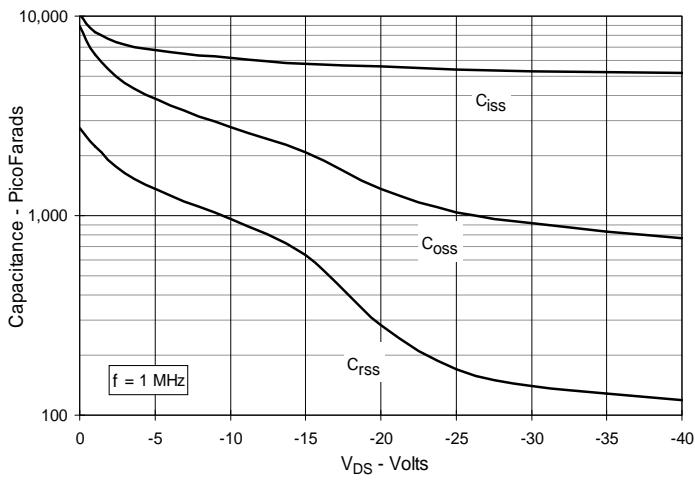
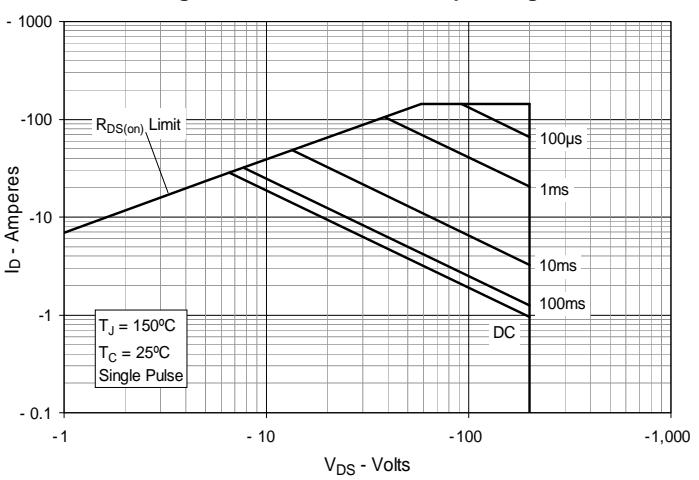
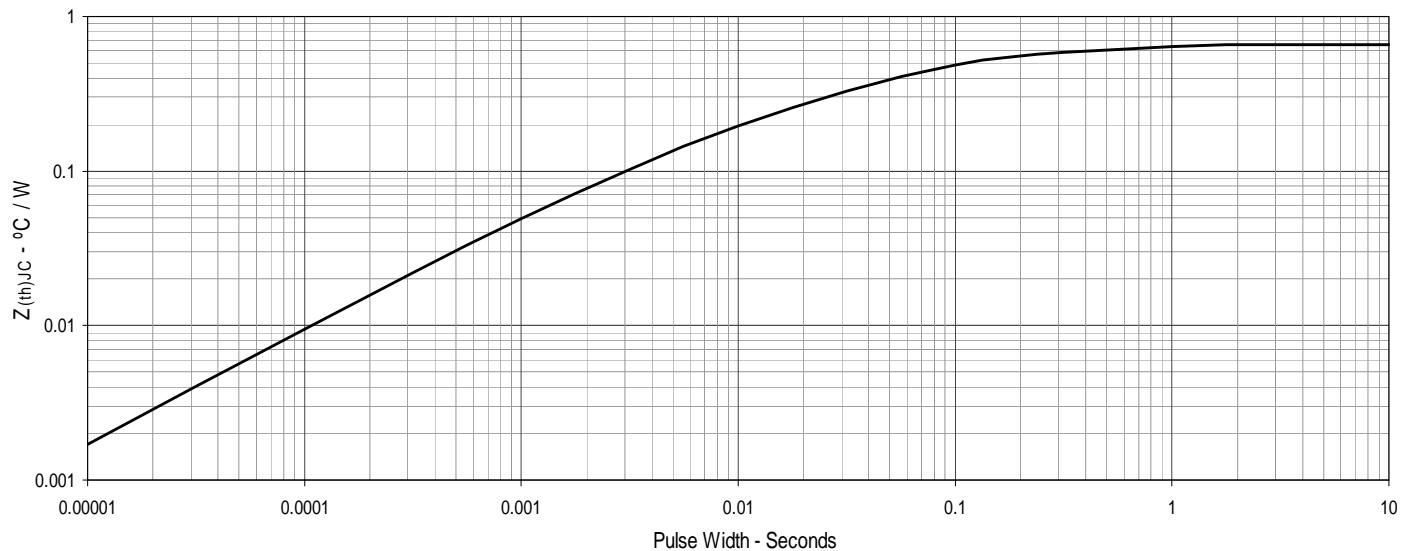
Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Forward Voltage Drop of Intrinsic Diode

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Forward-Bias Safe Operating Area


Fig. 13. Maximum Transient Thermal Impedance

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